

# Part Number: XZVS54S-9A

 $2.0 \times 1.25 \; mm$  UV LED With Ceramic Substrate

## **Features**

- 2.0 mm x 1.25 mm x 0.75 mm SMD LED
- Low power consumption
- Wide viewing angle
- Standard Package: 2,000pcs / Reel
- MSL (Moisture Sensitivity Level): 1
- ullet RoHS compliant

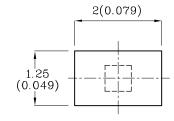


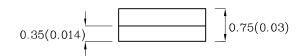


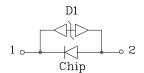
## ATTENTION

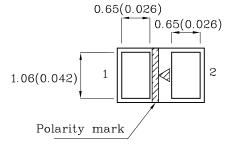
OBSERVE PRECAUTIONS
FOR HANDLING
ELECTROSTATIC
DISCHARGE
SENSITIVE
DEVICES

# Package Schematics









#### Notes:

- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is  $\pm 0.25 (0.01")$  unless otherwise noted.
- $3. \ {\rm Specifications}$  are subject to change without notice.



 $2.0 \times 1.25 \; mm$  UV LED With Ceramic Substrate

# **Handling Precautions**

www.SunLEDusa.com

Compare to epoxy encapsulant that is hard and brittle, silicone is softer and flexible. Although its characteristic significantly reduces thermal stress, it is more susceptible to damage by external mechanical force.

As a result, special handling precautions need to be observed during assembly using silicone encapsulated LED products. Failure to comply might lead to damage and premature failure of the LED.

1. Handle the component along the side surfaces by using forceps or appropriate tools.



2. Do not directly touch or handle the silicone lens surface. It may damage the internal circuitry.







3. Do not stack together assembled PCBs containing exposed LEDs. Impact may scratch the silicone lens or damage the internal circuitry.

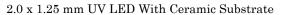


4. As silicone encapsulation is permeable to gases, some corrosive substances such as H<sub>2</sub>S might corrode silver plating of leadframe. Special care should be taken if an LED with silicone encapsulation is to be used near such substances.

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## Part Number: XZVS54S-9A





Part Number Emitting Color (Material)

Lens-color

Radiant Flux CIE127-2007\*  $(I_F=20mA)$   $\Phi e=mW$  [2]

 $\begin{array}{c} \text{Viewing} \\ \text{Angle} \\ 2\theta \ 1/2[1] \end{array}$ 

			min.	typ.	
XZVS54S-9A	Ultraviolet (InGaN)	Water Clear	8.6*	12*	150°

#### Notes:

- $1. \theta 1/2$  is the angle from optical centerline where the luminous intensity is 1/2 of the optical peak value.
- 2. Radiant flux: +/-15%.

## Electrical / Optical Characteristics at T<sub>A</sub>=25°C

Parameter	Symbol	Value	Unit	
Wavelength at Peak Emission I <sub>F</sub> = 20mA [Min.]	$\lambda_{ m peak}$	360*		
Wavelength at Peak Emission I <sub>F</sub> = 20mA [Typ.]		365*	nm	
Wavelength at Peak Emission $I_F = 20 \text{mA}$ [Max.]		370*		
Spectral Bandwidth at 50% $\Phi$ REL MAX $I_F$ = 20mA [Typ.]	Δλ	10	nm	
Forward Voltage I <sub>F</sub> = 20mA [Typ.]	V <sub>F</sub> [1]	3.3	V	
Forward Voltage I <sub>F</sub> = 20mA [Max.]		3.8		
Reverse Current (V <sub>R</sub> = 5V) [Max.]	$I_{\mathrm{R}}$	50	μΑ	
Temperature Coefficient of $V_F$ $I_F = 20 mA, -10^{\circ} C \leq T \leq 85^{\circ} C$	$\mathrm{TC}_{\mathrm{V}}$	-3.0	mV/°C	

# Notes:

# Absolute Maximum Ratings at TA=25°C

Parameter	Symbol	Value	Unit
Power Dissipation	PD	120	mW
Reverse Voltage	$V_{\mathrm{R}}$	5	V
Junction Temperature	Tj	115	°C
Operating Temperature	$T_{\mathrm{op}}$	-40 to +85	°C
Storage Temperature	$T_{ m stg}$	-40 to +85	°C
DC Forward Current	${ m I_F}$	30	mA
Peak Forward Current	I <sub>FM</sub> [2]	100	mA
Thermal Resistance (Junction / Ambient)	Rth j-a <sup>[1]</sup>	100	°C/W
Thermal Resistance (Junction / Solder point)	Rth j-s [1]	50	°C/W

## Notes:

- 1.  $R_{th}$  j-a , $R_{th}$  j-s Results from mounting on PC board FR4 (pad size  $\geq 16$  mm $^2$  per pad).
- $2.\ 1/10$  Duty Cycle,  $0.1 \mathrm{ms}$  Pulse Width.
- 3. A Relative Humidity between 40% and 60% is recommended in ESD-protected work areas to reduce static build up during assembly process (Reference JEDEC/ JESD625-A and JEDEC/J-STD-033)

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XDSB9117 V1-Z Layout: Maggie L.

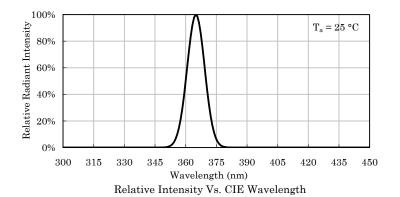
<sup>\*</sup>Radiant flux is in accordance with CIE127-2007 standards.

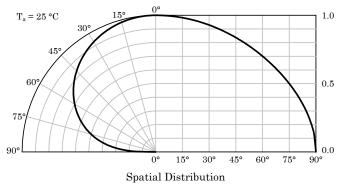
<sup>1.</sup> Forward voltage: ±0.1V.

 $<sup>\</sup>mbox{*}$  wavelength is in accordance with CIE127-2007 standards.

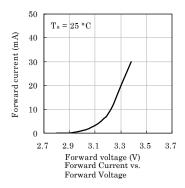


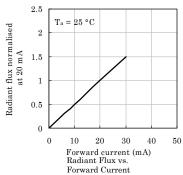


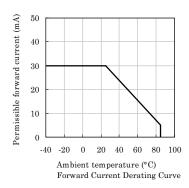


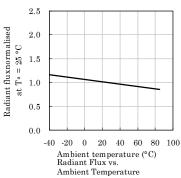


## **❖** Ultraviolet



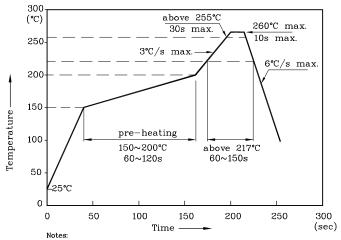






# LED is recommended for reflow soldering and soldering profile is shown below.

Reflow Soldering Profile for SMD Products (Pb-Free Components)



- 1. All temperatures refer to the center of the package,
- measured on the package body surface facing up during reflow.

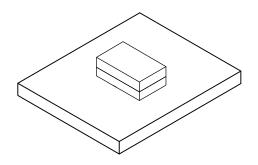
  2. Do not apply any stress to the LED during high temperature conditions.

  3. Maximum number of soldering passes: 2

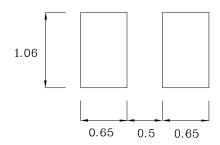




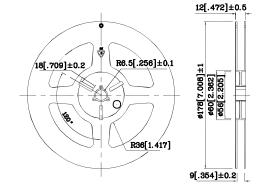
**❖** The device has a single mounting surface. The device must be mounted according to the specifications.



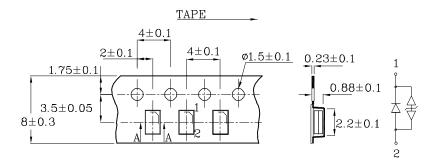
❖ Recommended Soldering Pattern (Units: mm; Tolerance: ± 0.1)



# **❖** Reel Dimension



# **❖** Tape Specification (Units:mm)



# Remarks:

If special sorting is required (e.g. binning based on forward voltage, Luminous intensity / luminous flux, or wavelength), the typical accuracy of the sorting process is as follows:

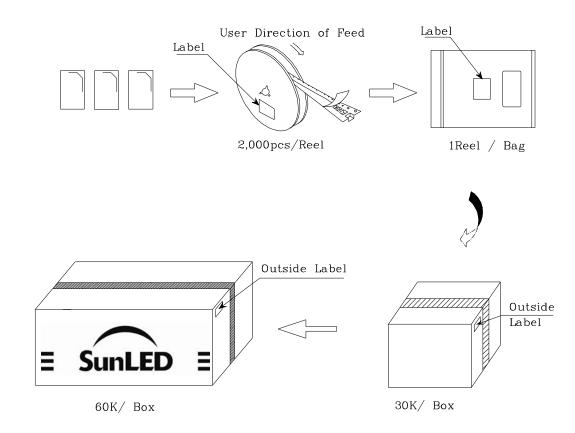
- 1. Wavelength: +/-1nm
- 2. Luminous intensity / luminous flux: +/-15%
- 3. Forward Voltage: +/-0.1V

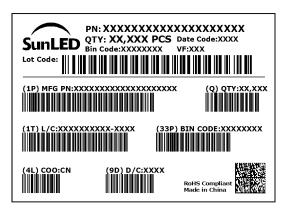
Note: Accuracy may depend on the sorting parameters.





# PACKING & LABEL SPECIFICATIONS





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